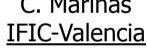




Thermal activities (Update)

C. Marinas





EVO meeting - 10.11.2010







Outline



Thermal mockup

• Status since Valencia (New parts availiable!)

CO₂ Cooling Plant

• (Example) ATLAS End Cap





THERMAL MOCKUP



Mock-up: Air cooling (Valencia meeting)



| Cooling | beam pipe temperature | Study impact of beam pipe temperature on PXD cooling | 1,6 Thermal Issues | Carlos Marinas |
|---------|--------------------------|---|--------------------|----------------|
| Cooling | Air Cooling | Engineer air cooling (together with SVD, common dry volume) Valencia and Karlsruhe & Vienna | 1,6 Thermal Issues | Carlos Marinas |
| Cooling | mockup | Valencia to design small cooling mockup | 1,6 Thermal Issues | Carlos Marinas |
| Cooling | Air Cooling | Test performance of carbon tubes (mass flow,vibrations) | 1,6 Thermal Issues | Carlos Marinas |

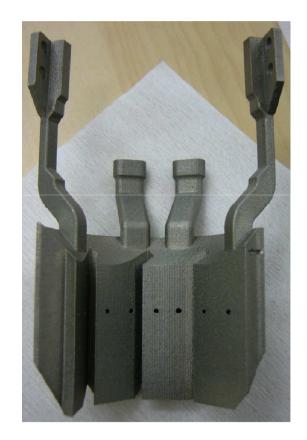
- Working on a PXD mock-up inside a polycarbonate cylinder (thermal images)
- Al-beam pipe with cooling (15°C)
- Transparent dummy ladders to have access to the inner layer and study vibrations
- Support structures similar to the final ones but with mono-phase cooling (CO₂ could be implemented if needed)
- Carbon tubes can be added
- Ladders: Samples with integrated resistors

Cooling blocks

Stainless steel 3D laser sintering







The pieces are a bit thicker to recover the right dimensions after polishing the surfaces

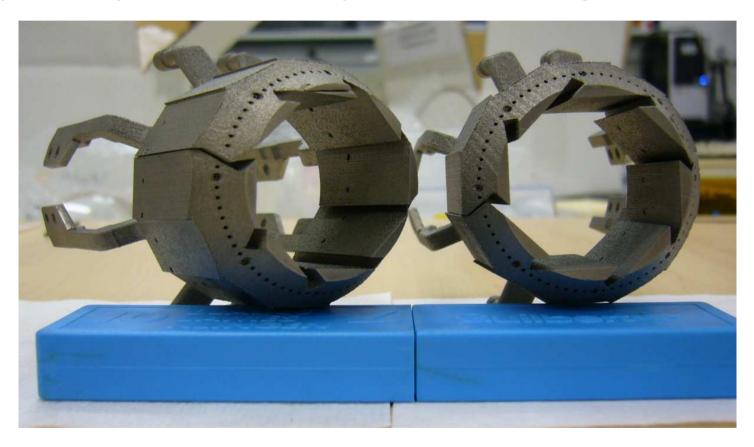
Two holes to accomodate *old* and *new* samples



Cooling blocks



The support structures will be populated with dummies (made in polycarbonate) and two silicon samples with resistors integrated





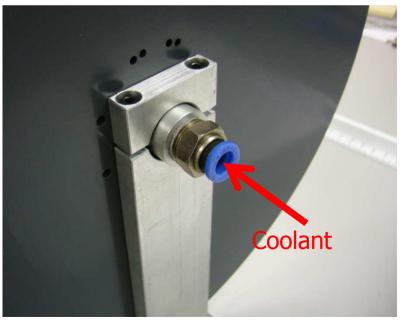
(Not tested yet!)

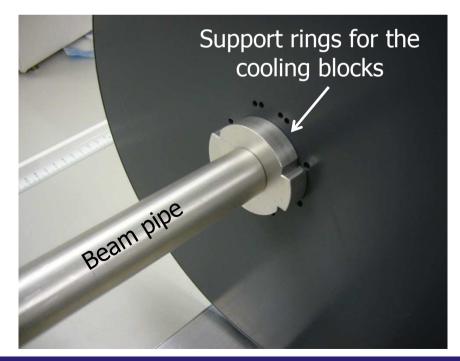
Beam pipe









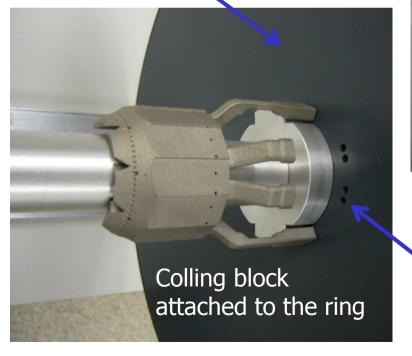


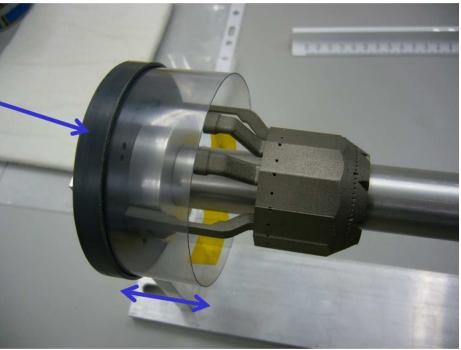


Support rings and working volume



Two PVC "endcaps" will define the working volume: PXD standalone or PXD+SVD





The polycarbonate screen will be extended to cover the full volume

Holes for the services (air and coolant)





CO₂ COOLING PLANT



ATLAS EC Petal layout

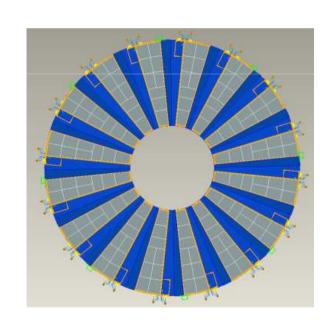
Cooling System is one of the key points for ID operation Heat density is 4-7 times higher than the current SCT module

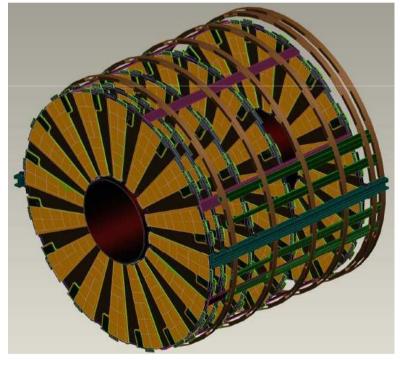
Detector thermal runaway impose to operate the silicon wafer below -20°C

$$T_{\text{sensor}} = T_{\text{coolant}} + \Delta T_{\text{Heat_Path}}$$

 \rightarrow Coolant: Less than -30 °C is considered for the pipe temperature (CO₂)





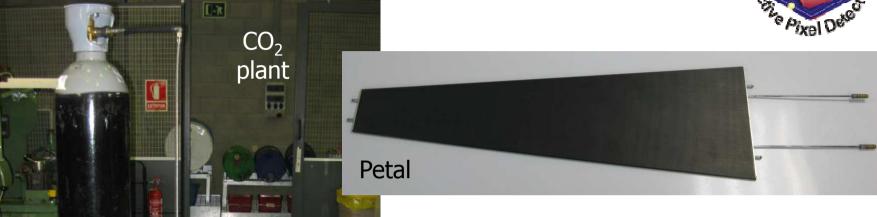


Sensors assembled in petals, petals on disks, and disks in the endcap support structure



CO₂ cooling plant





11

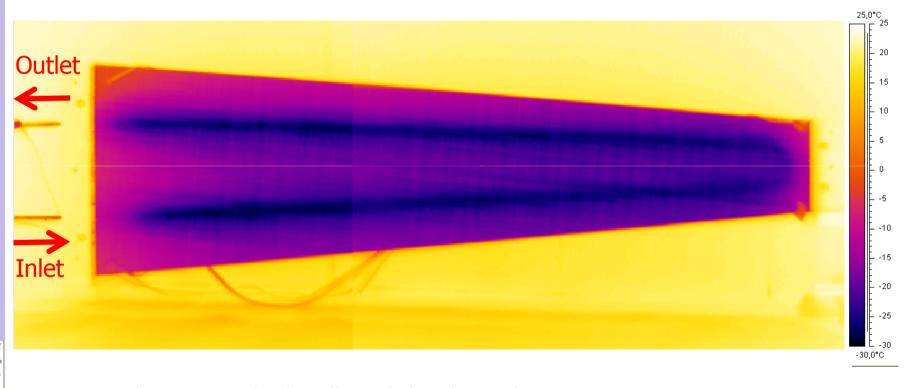




Fully operational!

Thermal image







The CO_2 worked well until the desired temperature: \sim -25°C Further tests expected in a near future (minimal temperature)





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